



Series: Ceramic Chip

Description: 2.5-2.69GHz US-WiMAX

PART NUMBER: W3020









Features:

- · Omnidirectional radiation
- Low profile
- Compact size WxLxH (3.2 x1.6 x 1.1mm)
- Low weight (33mg)
- Fully SMD compatible
- · Lead free soldering compatible
- Tape and reel packing
- RoHS compliant

Applications:

- 2.5-2.69 GHz
- LTE B38, B41
- Devices using WiMAX

All dimensions are in mm / inches

Issue: 1742

In the effort to improve our products, we reserve the right to make changes judged to be necessary. CONFIDENTIAL AND PROPRIETARY INFORMATION

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TECHNICAL DATA SHEET

Description: 2.5-2.69GHz US-WiMAX

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ELECTRICAL SPECIFICATIONS

Frequency 2.5-2.69 GHz

Nominal Impedance 50Ω

Return Loss(Typical)* <-5.5dB

Max Gain* 2.9dBi (Peak)

1.5dBi (Band Edges)

Radiation Efficiency* 89%/-0.52dB (Peak)

72%/-1.43dB(Band Edges)

Note: Electrical characteristics depend on test board (GP) size and antenna positioning on GP and Ground Clearance area size.

*Tested on PULSE testboard position 1 (refer to page 10) . The testboard size 80x35 mm, PWB ground clearance area 4.0 x 6.25 mm. 1.0pF shunt matcing capacitor used.



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MECHANICAL SPECIFICATIONS

Weight 0.033 g

Size 3.2 x1.6 x 1.1mm

ENVIRONMENTAL SPECIFICATIONS

Operating temperature -40~+85° C

Temperature -40~+85° C

Humidity Cyclic 6 +25° C/+55° C 95%

Vibration

Sinusoidal 2-8Hz 7.5 mm

Sinusoidal 8-200Hz 20 m/s²

Shocks 0.5 m/s

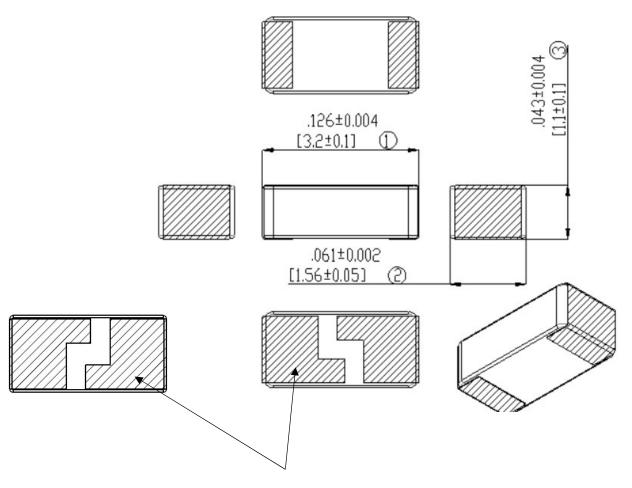
Salt mist 96 hours



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MECHANICAL DRAWING AND TERMINAL CONFIGURATION



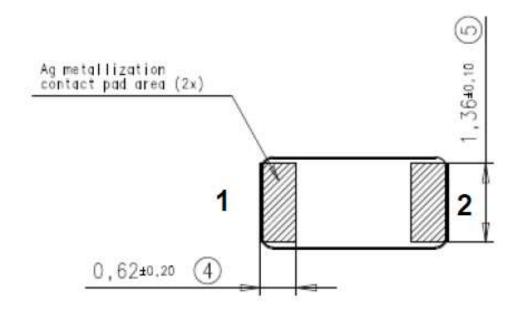
- 1. Antenna is symmetrical, both of antenna pattern have same RF performance.
- 2. The size of slot is only for reference.

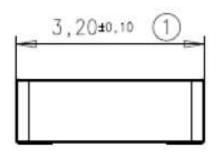


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MECHANICAL DRAWING AND TERMINAL CONFIGURATION





No.	Terminal Name	Terminal Dimensions
1	Feed / GND	0.62 x 1.36 mm
2	Feed / GND	0.62 x 1.36 mm





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OTHER SPECIFICATIONS

W3020 US-WiMax Antenna PWB Layout Specifications

Ground cleared under antenna, clearance area 4.00 x 6.25 mm

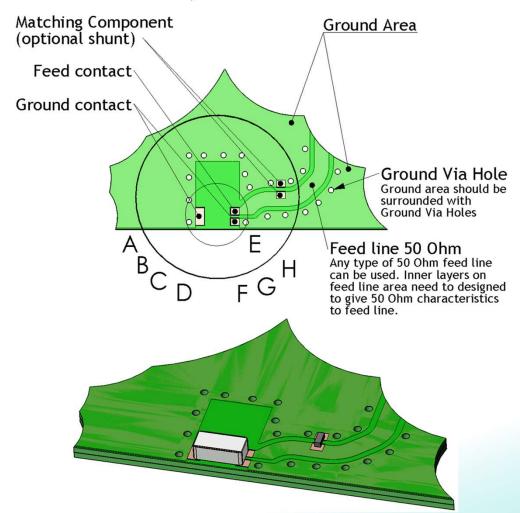
Matching and tuning component value and placement depend on application and surrounding mechanics / materials.

Feed line should be designed to match 50 Ω characteristic impedance, depending on PWB material and thickness.

Recommended test board layout for electrical characteristic measurement, test board outline size 80×37 mm.

PWB layout for W3020 2.5-2.69GHz US-WiMax Antenna

Note: All dimensions are in metric system.









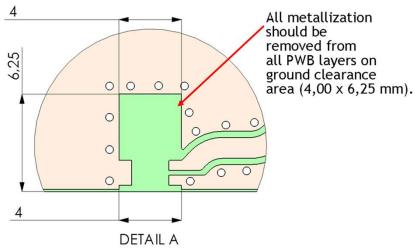
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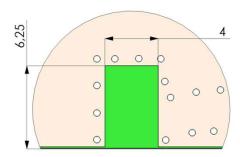
OTHER SPECIFICATIONS

Ground clearance area for W3020 US-WiMax Antenna

Ground clearance area (4,00 x 6,25 mm)

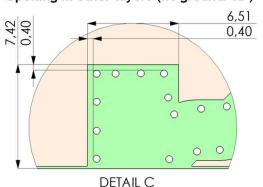


Opening in bottom/inner ground layers



DETAIL B

Opening in other layers (no ground/RF)







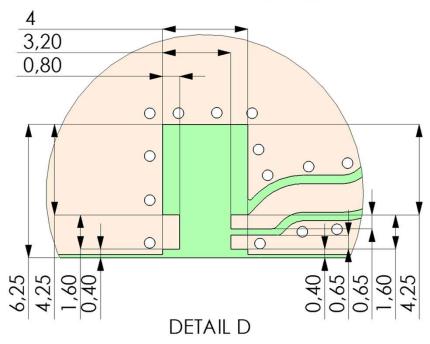
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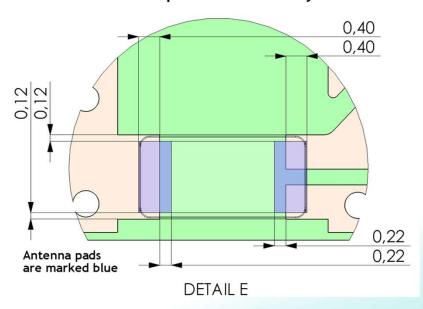
OTHER SPECIFICATIONS

PWB pad dimensions and antenna position for W3020 US-WiMax Antenna

Pad dimensions in top copper



Antenna position on PWB layout







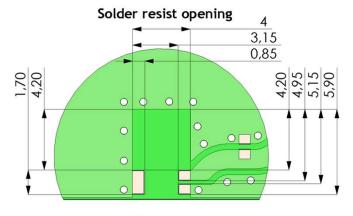
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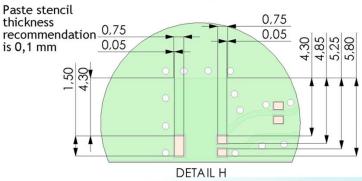
Typical Ground via hole placement in PWB layout for W3020 US-WiMax Distance Antenna between Distance between all via holes all via holes **Ground Via holes** and copper edge and copper edge should should be 0,35 mm 1,40 be 0,26 mm 0,35 Distance between all via holes should be max 1,50 mm 3 1,37

Solder resist opening and paste stencil recommendations for W3020 US-WiMax Antenna



DETAIL G

Paste stencil recommendation



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ROHS



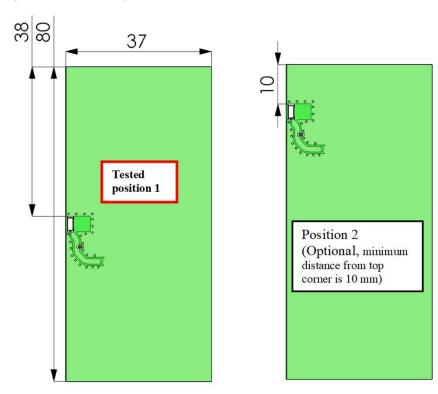
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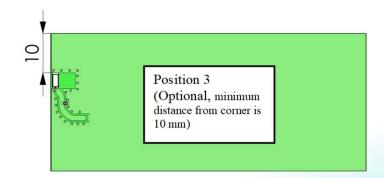
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OTHER SPECIFICATIONS

Recommended antenna position on PWB for W3020 US-WiMax Antenna

Pulse test PWB size is 37×80 mm, other sized boards can be used depending on customer device size (minimum 35×35 mm)







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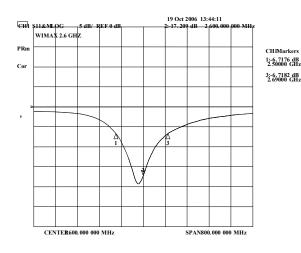
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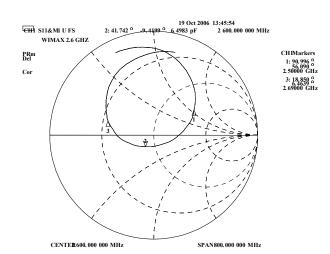
CHARTS

W3020 US-WiMax 2.5-2.69GHz Test Set Up and **Measured Performance**

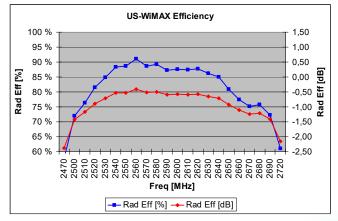
Ground cleared under antenna, clearance area 4.00 x 6.25 mm

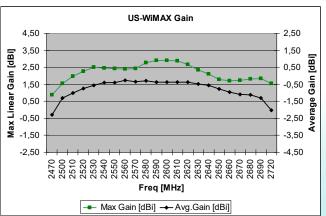
Measured on the 80 x 37mm test board with matching circuit (shunt 1.0 pF) and in antenna position 1 on PWB layout, see page 9.





Typical Return Loss S11/ impedance, free space efficiency and gain





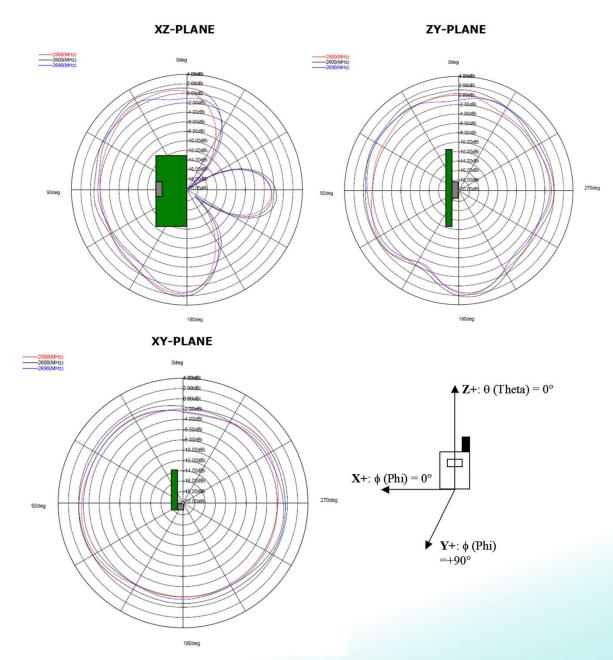


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CHARTS

Typical Free Space Radiation Patterns



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ROHS

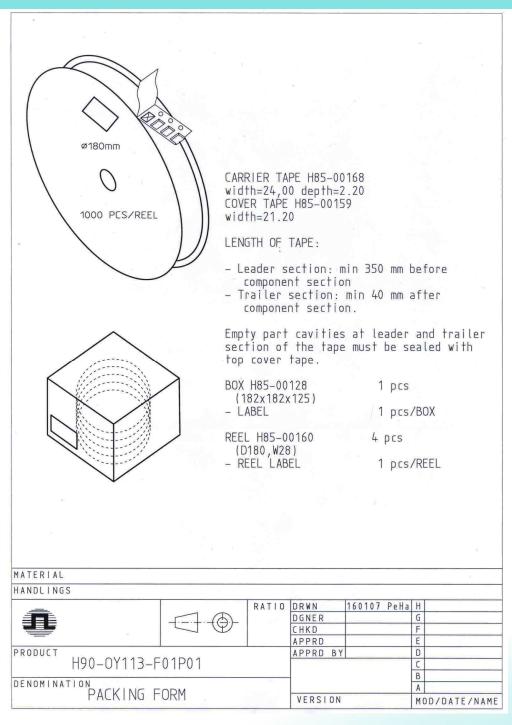




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PACKAGING





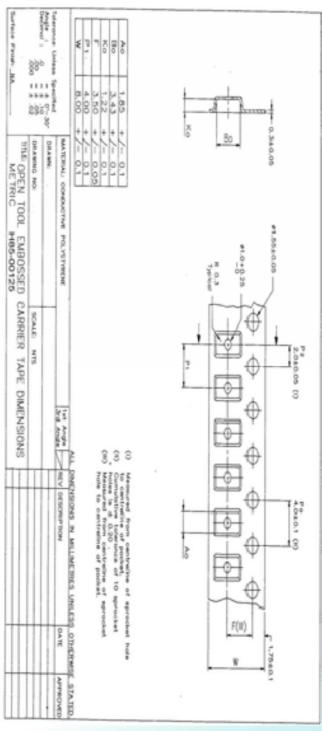




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PACKAGING



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